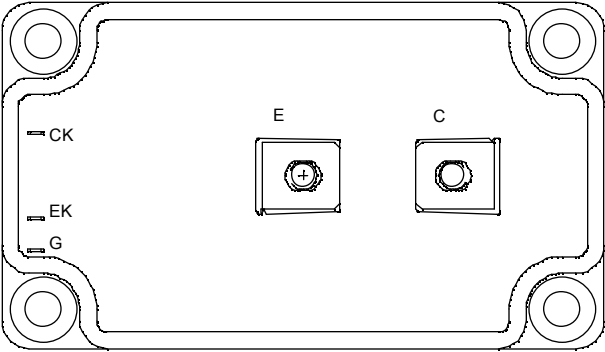
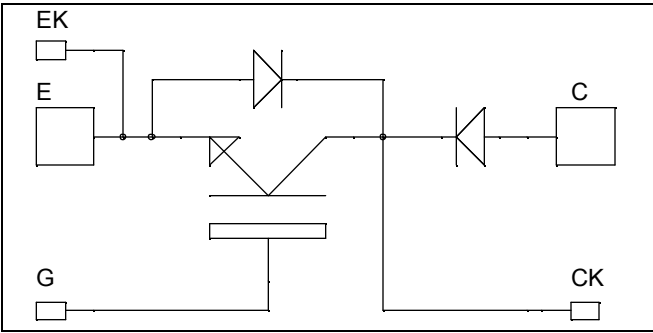


**Single Switch
with Series diodes
NPT IGBT Power Module**

**$V_{CES} = 1200V$
 $I_C = 200A @ T_c = 80^\circ C$**



Application

- Zero Current Switching resonant mode

Features

- Non Punch Through (NPT) FAST IGBT
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 50 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - Avalanche energy rated
 - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
 - Symmetrical design
 - M5 power connectors
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCESat
- Low profile

Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage		1200	V
I_C	Continuous Collector Current	$T_c = 25^\circ C$	275	A
		$T_c = 80^\circ C$	200	
I_{CM}	Pulsed Collector Current	$T_c = 25^\circ C$	600	
V_{GE}	Gate - Emitter Voltage		± 20	V
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$	1136	W
SSOA	Switching Safe Operating Area	$T_j = 150^\circ C$	600A @ 1200V	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
BV_{CES}	Collector - Emitter Breakdown Voltage	$V_{GE} = 0\text{V}, I_C = 1.5\text{mA}$	1200			V
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0\text{V}$ $V_{CE} = 1200\text{V}$			1.5	mA
		$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$		7.0		
$V_{CE(on)}$	Collector Emitter on Voltage	$V_{GE} = 15\text{V}$ $I_C = 200\text{A}$		3.2	3.7	V
		$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$		4.0		
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 4\text{mA}$	4.5		6.5	V
I_{GES}	Gate - Emitter Leakage Current	$V_{GE} = \pm 20\text{V}, V_{CE} = 0\text{V}$			± 300	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit		
C_{ies}	Input Capacitance	$V_{GE} = 0\text{V}$		13.8		nF		
C_{oes}	Output Capacitance	$V_{CE} = 25\text{V}$		1.32				
C_{res}	Reverse Transfer Capacitance	$f = 1\text{MHz}$		880				
Q_g	Total gate charge	$V_{GS} = 15\text{V}$		1320		nC		
Q_{ge}	Gate - Emitter Charge	$V_{Bus} = 600\text{V}$		140				
Q_{gc}	Gate - Collector Charge	$I_C = 200\text{A}$		800				
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C) $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ $I_C = 200\text{A}$ $R_G = 1.2\Omega$		35				
T_r	Rise Time			65				
$T_{d(off)}$	Turn-off Delay Time			320				
T_f	Fall Time			30				
E_{on}	Turn-on Switching Energy			21.6				
E_{off}	Turn-off Switching Energy			9.2				
$T_{d(on)}$	Turn-on Delay Time		Inductive Switching (125°C) $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ $I_C = 200\text{A}$ $R_G = 1.2\Omega$		35			ns
T_r	Rise Time				65			
$T_{d(off)}$	Turn-off Delay Time				360			
T_f	Fall Time				40			
E_{on}	Turn-on Switching Energy			27.9				
E_{off}	Turn-off Switching Energy			12.2				

Series diode ratings and characteristics

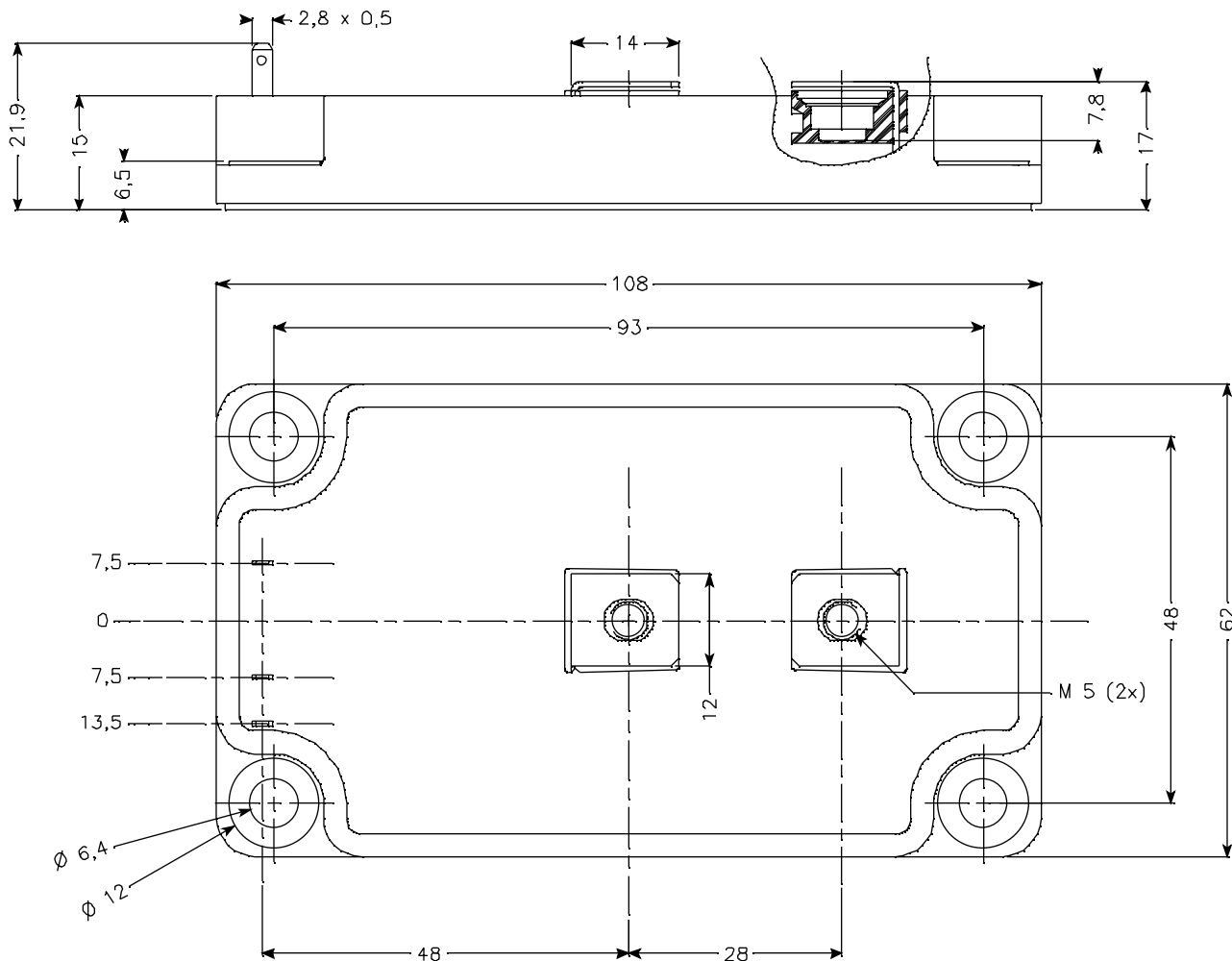
Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
V_{RRM}	Maximum Repetitive Reverse Voltage		1200			
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle $T_c = 70^\circ\text{C}$		240		A
V_F	Diode Forward Voltage	$I_F = 240\text{A}$		2	2.5	V
		$I_F = 480\text{A}$		2.3		
		$I_F = 240\text{A}$ $T_j = 125^\circ\text{C}$		1.8		
t_{rr}	Reverse Recovery Time	$I_F = 240\text{A}$ $V_R = 800\text{V}$ $di/dt = 800\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$	400		ns
			$T_j = 125^\circ\text{C}$	470		
Q_{rr}	Reverse Recovery Charge	$I_F = 240\text{A}$ $V_R = 800\text{V}$ $di/dt = 800\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$	4.8		μC
			$T_j = 125^\circ\text{C}$	16		

Thermal and package characteristics

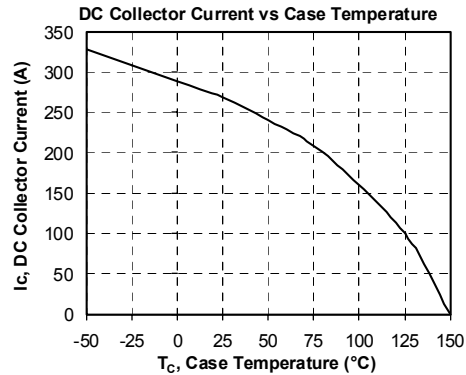
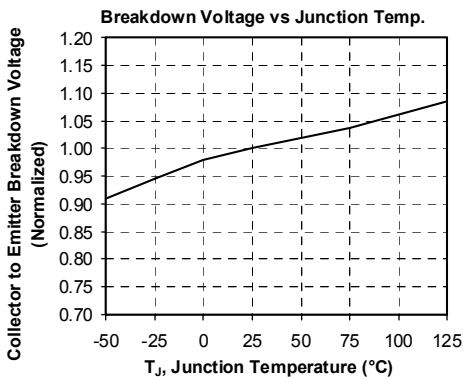
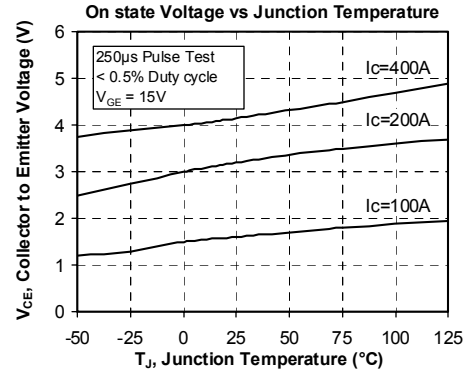
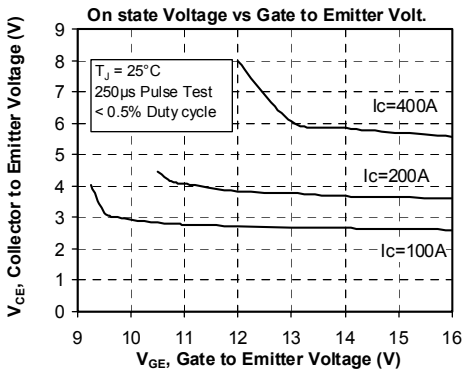
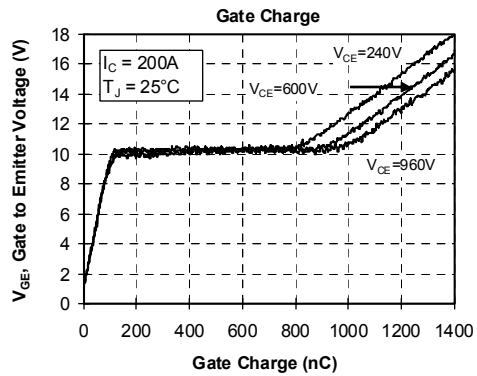
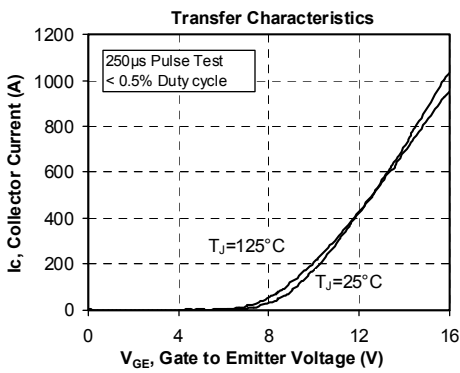
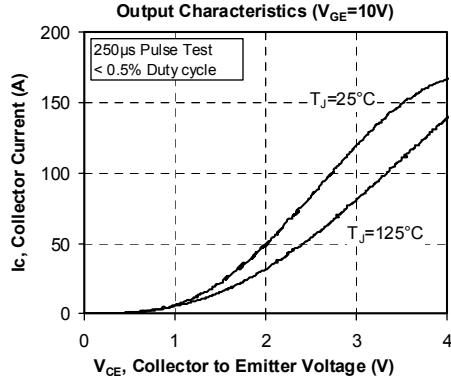
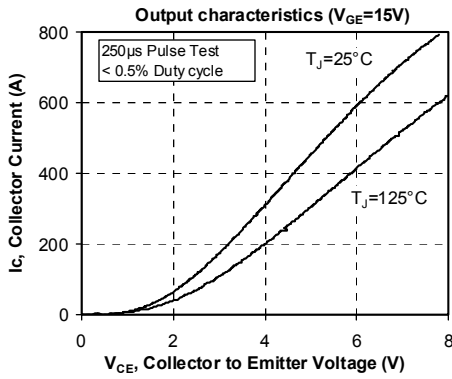
Symbol Characteristic

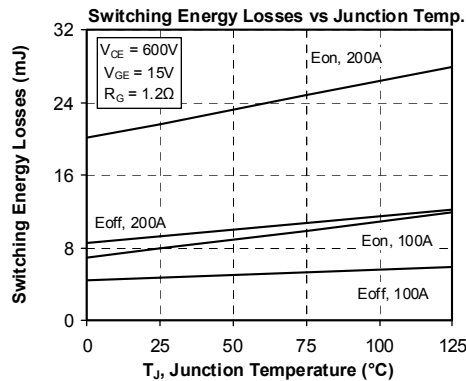
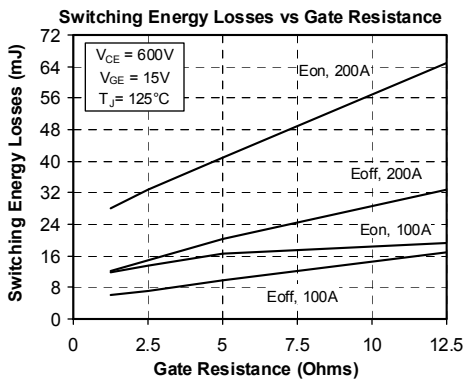
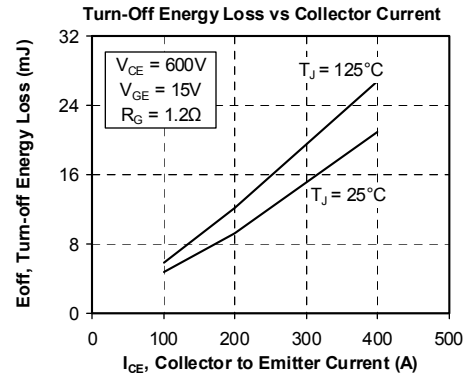
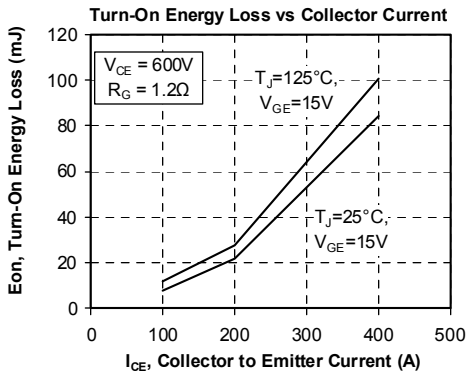
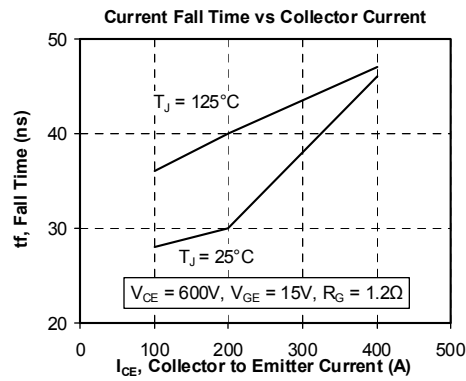
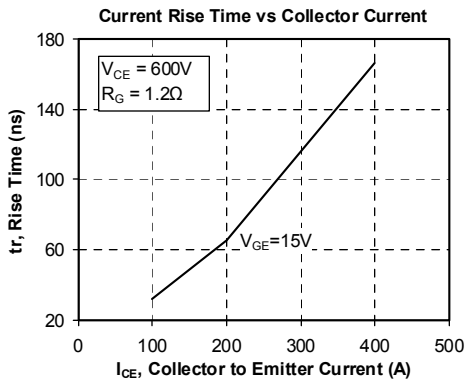
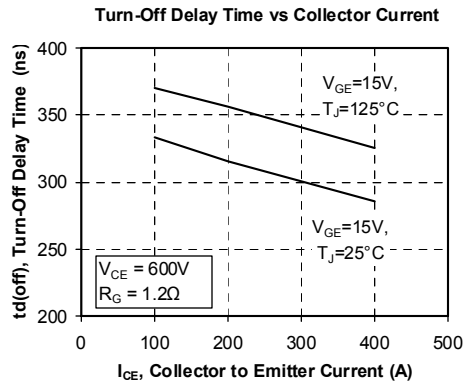
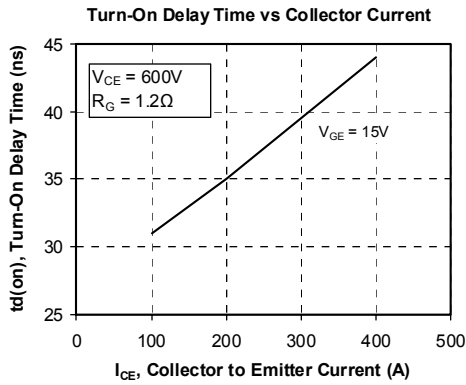
			Min	Typ	Max	Unit
R _{thJC}	Junction to Case	IGBT			0.11	°C/W
		Diode			0.23	
V _{ISOL}	RMS Isolation Voltage, any terminal to case t=1 min, I _{isol} <1mA, 50/60Hz		2500			V
T _J	Operating junction temperature range		-40		150	°C
T _{STG}	Storage Temperature Range		-40		125	
T _C	Operating Case Temperature		-40		100	
Torque	Mounting torque	To heatsink	M6	3	5	N.m
		For terminals	M5	2	3.5	
Wt	Package Weight				280	g

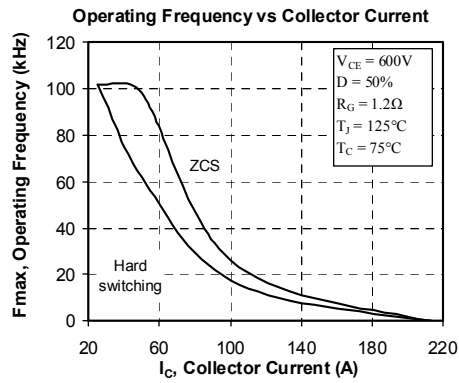
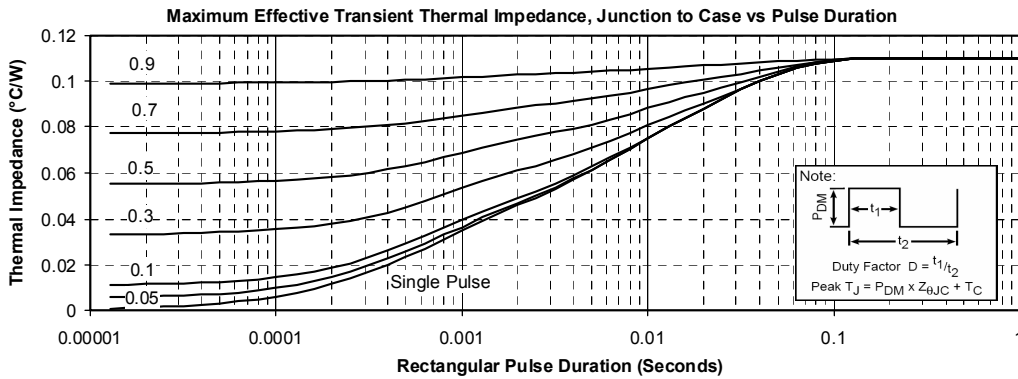
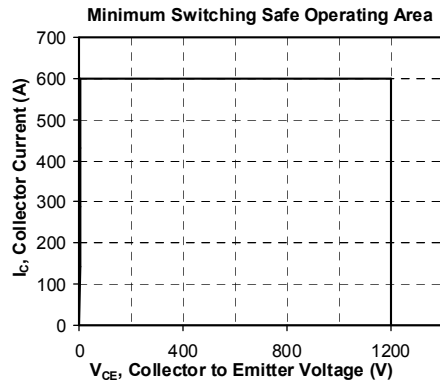
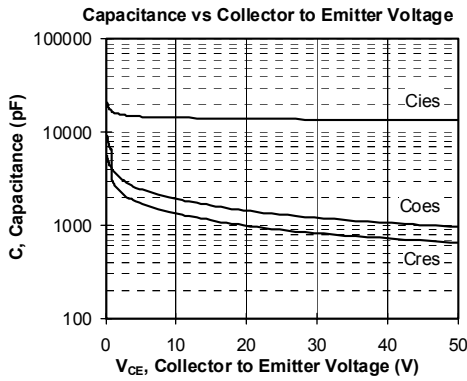
Package outline



Typical Performance Curve







APT reserves the right to change, without notice, the specifications and information contained herein

APT's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S. and Foreign patents pending. All Rights Reserved.